

## 3.0x2.0mm SURFACE MOUNT LED LAMP



**ATTENTION OBSERVE PRECAUTIONS** FOR HANDLING **ELECTROSTATIC** DISCHARGE SENSITIVE **DEVICES** 

Part Number: AA3021LVBS/D Blue

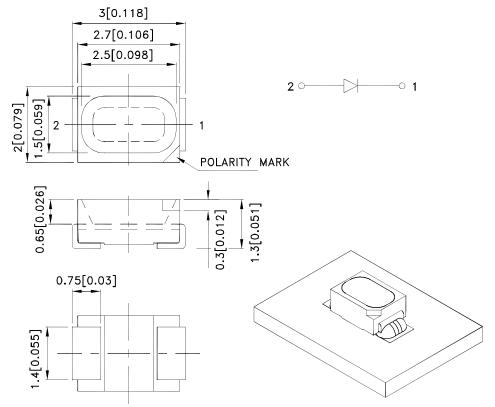
### **Features**

- 3.0mm x 2.0mm, 1.3mm high, only minimum space required.
- Suitable for compact optoelectronic applications.
- Low power consumption.
- Package: 2000pcs / reel.
- Moisture sensitivity level : level 3.
- Low current IF=2mA operating.
- RoHS compliant.

## **Descriptions**

- The Blue source color devices are made with InGaN Light Emitting Diode.
- Electrostatic discharge and power surge could damage the LEDs.
- It is recommended to use a wrist band or antielectrostatic glove when handling the LEDs.
- All devices, equipments and machineries must be electrically grounded.

## **Package Dimensions**



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- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is  $\pm 0.2 (0.008")$  unless otherwise noted.
- The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.
   The device has a single mounting surface. The device must be mounted according to the specifications.

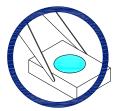
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### **Handling Precautions**

Compare to epoxy encapsulant that is hard and brittle, silicone is softer and flexible. Although its characteristic significantly reduces thermal stress, it is more susceptible to damage by external mechanical force.

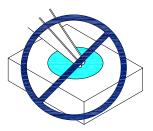
As a result, special handling precautions need to be observed during assembly using silicone encapsulated LED products. Failure to comply might lead to damage and premature failure of the LED.

1. Handle the component along the side surfaces by using forceps or appropriate tools.

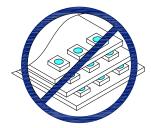


2. Do not directly touch or handle the silicone lens surface. It may damage the internal circuitry.

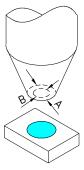




3. Do not stack together assembled PCBs containing exposed LEDs. Impact may scratch the silicone lens or damage the internal circuitry.



- 4.1. The inner diameter of the SMD pickup nozzle should not exceed the size of the LED to prevent air leaks.
- 4.2. A pliable material is suggested for the nozzle tip to avoid scratching or damaging the LED surface during pickup.
- 4.3. The dimensions of the component must be accurately programmed in the pick-and-place machine to insure precise pickup and avoid damage during production.



5. As silicone encapsulation is permeable to gases, some corrosive substances such as  $H_2S$  might corrode silver plating of leadframe. Special care should be taken if an LED with silicone encapsulation is to be used near such substances.

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## **Selection Guide**

Part No.	Dice	Lens Type	lv (mcd) [2] @ 2mA		Viewing Angle [1]
		2.	Min.	Тур.	201/2
AA3021LVBS/D	Blue (InGaN)	Water Clear	20	50	125°

### Notes:

- 1. 01/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.
  2. Luminous intensity/ luminous Flux: +/-15%.
  3. Luminous intensity value is traceable to the CIE127-2007 compliant national standards.

## Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Device	Min.	Тур.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Blue		465		nm	IF=2mA
λD [1]	Dominant Wavelength	Blue		470		nm	IF=2mA
Δλ1/2	Spectral Line Half-width	Blue		22		nm	IF=2mA
С	Capacitance	Blue		100		pF	VF=0V;f=1MHz
VF [2]	Forward Voltage	Blue	2.2	2.65	3	V	IF=2mA
lr	Reverse Current	Blue			50	uA	VR=5V

### Notes:

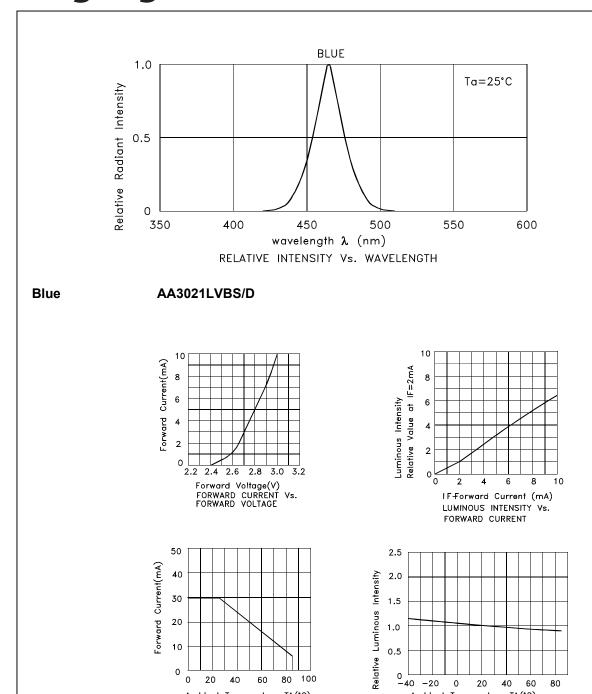
- 1.Wavelength: +/-1nm. 2.Forward Voltage: +/-0.1V.
- 3. Wavelength value is traceable to the CIE127-2007 compliant national standards.
- 4. Excess driving current and/or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

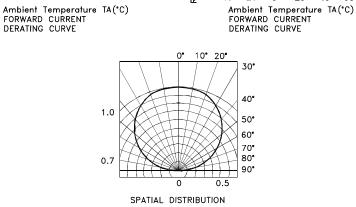
## Absolute Maximum Ratings at TA=25°C

Parameter	Blue	Units		
Power dissipation	90	mW		
DC Forward Current	30	mA		
Peak Forward Current [1]	100	mA		
Reverse Voltage	5	V		
Operating Temperature	-40°C To +85°C			
Storage Temperature	-40°C To +85°C			

1. 1/10 Duty Cycle, 0.1ms Pulse Width.

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-20 0 20

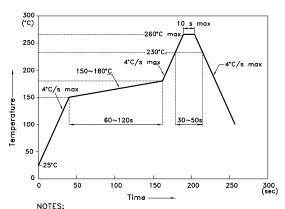
80 60

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## AA3021LVBS/D

Reflow soldering is recommended and the soldering profile is shown below. Other soldering methods are not recommended as they might cause damage to the product.

Reflow Soldering Profile For Lead-free SMT Process.



- NOTES:

  1.We recommend the reflow temperature 245°C(+/-5°C). The maximum soldering temperature should be limited to 260°C.

  2.Don't cause stress to the epoxy resin while it is exposed to high temperature. to high temperature.

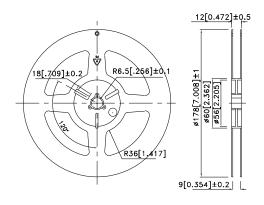
  3.Number of reflow process shall be 2 times or less.

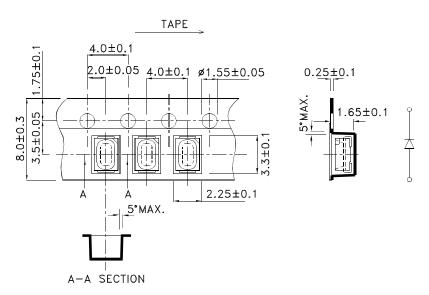
## **Recommended Soldering Pattern** (Units: mm; Tolerance: ± 0.1)

## 3 1.4 1.4

## **Tape Dimensions** (Units: mm)

## **Reel Dimension**

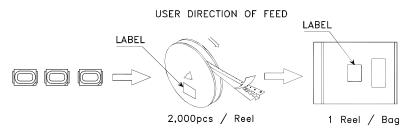


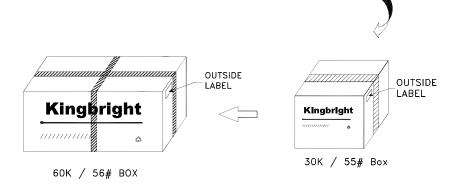


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# PACKING & LABEL SPECIFICATIONS

### AA3021LVBS/D







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